

SLIS133-NOVEMBER 2009

TANDEM 64-TAP DIGITAL POTENTIOMETER

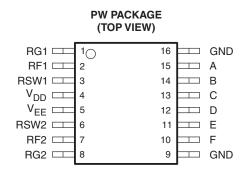
Check for Samples: TPL8002-25

FEATURES

- Adjustable Gain From 23.25 dB to –24 dB
- 64-Tap Positions With 0.75 dB Per Step
- Supports 8-MHz Analog Bandwidth
- Operating Range up to -4-V V_{EE}/+4-V V_{DD}
- 100-µA Maximum Static Supply Current
- ±30% End-to-End Resistance Tolerance
- Absolute Tolerance of ±0.3 dB
- Operating Temperature Range From -40°C to 85°C
- ESD Performance Tested Per JESD 22
 - 2000-V Human-Body Model (A114-B,Class II)

APPLICATIONS

 Tandem Adjustable Feedback and Gain Resistors for Operational Amplifers



DESCRIPTION/ORDERING INFORMATION

The TPL8002-25 is a programmable resistor device implementing two digital potentiometers with 64 wiper positions each that are tandem controlled through a 6-bit parallel interface. The device has fixed wiper resistances at the respective wiper contacts that tap the potentiometer resistors at a point determined by the binary code present at its digital inputs.

The resistive wiper tap terminals, RSW, of the TPL8002-25 are typically connected to the inverting inputs (–) of an external differential path inverting operational amplifier configuration, with the non-inverting inputs (+) connected through to ground. The application's differential input to the configuration is the device's RG terminals. The differential output of the external operational amplifiers is connected to the device's RF terminals, and thus becomes the differential output of the application configuration.

The resistance between the wiper contacts and the end points RG and RF of the TPL8002-25 provides a logarithmic gain/attenuation response of the configuration. With a digital code of decimal 0 (b000000) the configuration has an inverting maximum attenuation of -24 dB. With a digital code of decimal 32 (b100000) the configuration has inverting unity gain of 0.00 dB. With a digital code of decimal 63 (b11111) the configuration has an inverting maximum gain of +23.25 dB. The response of the configuration with respect to the digital code varies in fixed steps of 0.75 dB.

ORDERING INFORMATION

| T _A | PACKAGE ^{(1) (2)} | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|----------------------------|---------------|-----------------------|------------------|
| -40°C to 85°C | TSSOP – PW | Tape and reel | TPL8002-25PWR | PHY03A |

(1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

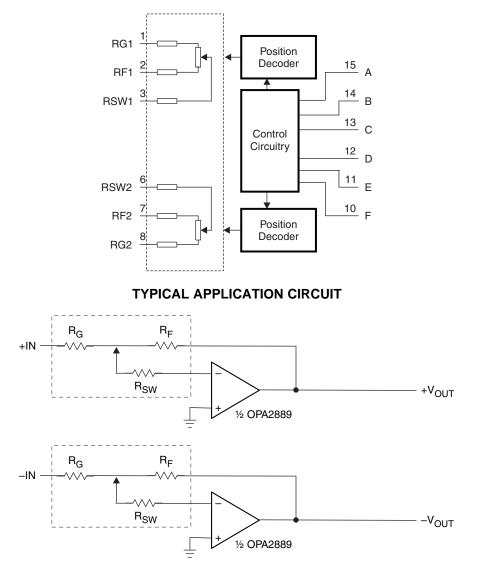


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FUNCTION TABLE

Table 1. Switch Truth Table

| | | R _G (Ω) | R _F (Ω) |
|--------|---|---|--|
| 111111 | 23.25 | 161 | 2339 |
| 111110 | 22.5 | 174 | 2326 |
| 111101 | 21.75 | 189 | 2311 |
| 111100 | 21 | 205 | 2295 |
| 111011 | 20.25 | 221 | 2279 |
| 111010 | 19.5 | 239 | 2261 |
| 111001 | 18.75 | 259 | 2241 |
| 111000 | 18 | 280 | 2220 |
| 110111 | 17.25 | 302 | 2198 |
| 110110 | 16.5 | 325 | 2175 |
| 110101 | 15.75 | 351 | 2149 |
| 110100 | 15 | 377 | 2123 |
| 110011 | 14.25 | 406 | 2094 |
| 110010 | 13.5 | 436 | 2064 |
| 110001 | 12.75 | 468 | 2032 |
| 110000 | 12 | 502 | 1998 |
| 101111 | 11.25 | 537 | 1963 |
| | | | 1925 |
| | | | 1886 |
| | | | 1845 |
| | | | 1803 |
| | | | 1758 |
| | | | 1713 |
| | | | 1665 |
| | | | 1617 |
| | | | 1567 |
| | | | 1516 |
| | | | 1464 |
| | | | 1411 |
| | | | 1358 |
| | | | 1304 |
| | | | 1250 |
| | | | 1250 |
| | | | 1190 |
| | | | 1089 |
| | | | 1089 |
| | | | 984 |
| | | | 984 |
| | | | 883 |
| | | | 835 |
| | | | 835 787 |
| | | | |
| | | | 742 |
| | | | 697 655 |
| | 111110 111101 11101 11101 11101 11101 11100 11100 11100 11100 11100 11100 11000 11010 11010 11000 11001 11000 11000 11000 11000 11000 10101 10110 10110 10110 10100 100101 100101 100101 100101 100101 100101 100001 100010 100001 100001 100001 100001 100001 100001 100001 100001 011101 011101 011010 011010 011010 011010 010111 0 | 111110 22.5 111101 21.75 111100 21 11101 20.25 11101 19.5 11100 19.5 11100 18.75 11100 18.75 11100 18.75 11011 17.25 11010 16.5 11011 15.75 11001 15.75 11001 15.75 11001 13.5 11000 12 10101 12.75 110000 12 101111 11.25 101000 12 101111 11.25 101101 9.75 101100 9 101101 8.25 101101 8.25 101001 6.75 101001 3.75 100101 3.75 100101 3.75 100101 1.5 100101 1.5 100010 <td< td=""><td>111110 22.5 174 111101 21.75 189 111100 21 205 111011 20.25 221 111010 19.5 239 111000 18 280 11011 17.25 302 11010 16.5 325 11010 15.75 351 11000 15 377 11001 13.5 436 11000 12 502 10111 11.25 537 10010 13.5 468 110000 12 502 101111 11.25 537 101010 12.5 546 110000 12 502 101111 14.25 697 101101 9.75 614 101100 7.5 742 101010 7.5 787 101010 6.75 787 101010 3.75 984 <</td></td<> | 111110 22.5 174 111101 21.75 189 111100 21 205 111011 20.25 221 111010 19.5 239 111000 18 280 11011 17.25 302 11010 16.5 325 11010 15.75 351 11000 15 377 11001 13.5 436 11000 12 502 10111 11.25 537 10010 13.5 468 110000 12 502 101111 11.25 537 101010 12.5 546 110000 12 502 101111 14.25 697 101101 9.75 614 101100 7.5 742 101010 7.5 787 101010 6.75 787 101010 3.75 984 < |

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DECIMAL

CONTROL

TPL8002-25

| | | . , | |
|--------|----------------|--------------------|--|
| FEDCBA | GAIN/ATTN (dB) | R _G (Ω) | |
| 010011 | -9.75 | 1886 | |
| 010010 | -10.5 | 1925 | |
| 010001 | -11.25 | 1963 | |

-12

-12.75

-13.5

-14.25

-15

-15.75

-16.5

-17.25

-18

-18.75

-19.5

-20.25

-21

-21.75

-22.5

-23.25

-24

Table 1. Switch Truth Table (continued)

R_F (Ω)

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ABSOLUTE MAXIMUM RATINGS⁽¹⁾ ⁽²⁾

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|-------------------|---|--------------------------------|-----------------------|-----------------------|------|
| $V_{DD} - V_{EE}$ | Power supply delta voltage ⁽³⁾ | | | 10 | V |
| V _{DD} | Positive supply voltage range ⁽³⁾ | | -0.3 | 5 | V |
| V _{EE} | Negative supply voltage range ⁽³⁾ | | 0.3 | -5 | V |
| V _{IN} | Control input voltage range ⁽²⁾ (3) | | -0.3 | V _{DD} + 0.3 | V |
| V _{I/O} | Resistor I/O voltage range ^{(2) (3) (4)} | | V _{EE} - 0.3 | V _{DD} + 0.3 | V |
| I _{IK} | Control input clamp current | $V_{IN} < 0$ and $V_{I/O} < 0$ | | -18 | mA |
| I _{I/OK} | I/O port clamp current | $V_{IN} < 0$ and $V_{I/O} < 0$ | | -18 | mA |
| T _{stg} | Storage temperature range | | -40 | 85 | °C |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to ground, unless otherwise specified.

(3) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

(4) V_1 and V_0 are used to denote specific conditions for $V_{1/0}$.

RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

| | | MIN | TYP | MAX | UNIT |
|-------------------|----------------------------------|----------------------|------|----------------------|------|
| $V_{DD} - V_{EE}$ | Power supply delta voltage | | | 8 | V |
| V _{DD} | Positive supply voltage | 2.5 | 3.6 | 4 | V |
| V _{EE} | Negative supply voltage | -2.5 | -3.6 | -4 | V |
| V _{IH} | High-level control input voltage | $V_{DD} \times 0.65$ | | | V |
| V _{IL} | Low-level control input voltage | | | $V_{DD} \times 0.35$ | V |
| VI | Control input voltage | GND | | V _{DD} | V |
| V _{I/O} | Resistor inputs/outputs | V _{EE} | | V _{DD} | V |
| T _A | Operating free-air temperature | -40 | | 85 | °C |

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ELECTRICAL CHARACTERISTICS Dual ±4-V Supply

over operating free-air temperature range (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------------------------|------------------------------------|--|------|-----|------|------|
| V _{IK} | - Control inputs | $V_{DD} = 4 \text{ V}, \text{ I}_{IN} = -18 \text{ mA}$ | | | -1.8 | V |
| I _{IN} | Control inputs | $V_{DD} = 4 V, V_{IN} = V_{DD} \text{ or } GND$ | | | ±1 | μA |
| I _{DD} + I _{EE} | | $V_{DD} = 4 \text{ V}, V_{EE} = -4 \text{ V}, V_{IN} = V_{DD} \text{ or GND}, I_{I/O} = 0$ | | | 100 | μA |
| C _{IN} | Control capacitance ⁽¹⁾ | $V_{DD} = 4 V, V_{IN} = V_{DD} \text{ or } GND$ | | 3.2 | | pF |
| C _{RG} | RG capacitance ⁽¹⁾ | $V_{IN} = 0 V$, frequency = 10 MHz | | 45 | | pF |
| C _{RF} | RF capacitance ⁽¹⁾ | $V_{IN} = 0 V$, frequency = 10 MHz | | 45 | | pF |
| C _W | Wiper capacitance ⁽¹⁾ | $V_{IN} = 0 V$, frequency = 10 MHz | | 45 | | pF |
| R | End-to-end resistance | | 1.75 | 2.5 | 3.25 | kΩ |
| R _W | Wiper resistance | | | | 420 | Ω |
| INL | Integral nonlinearity | | -0.3 | | 0.3 | dB |
| DNL | Differential nonlinearity | | -0.3 | | 0.3 | dB |

(1) The AC method is a frequency domain measurement. A 10-MHz ac voltage signal of known dc offset and amplitude of 82.5 mV are applied to the pin under test. The imaginary component of the complex current is measured and used in the equation: C = I_{im} / (2 × π × F × V_{IN}) where I_{im} = imaginary component of input current, V_{IN} = magnitude of input voltage, and F = frequency.

SWITCHING CHARACTERISTICS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------|-----------------------------|-------------------------------------|-----|-----|-----|------|
| t _{PS} | Contol to output step delay | | | 100 | | ns |
| BW | Analog signal bandwidth | For a typical example, see Figure 2 | 8 | | | MHz |

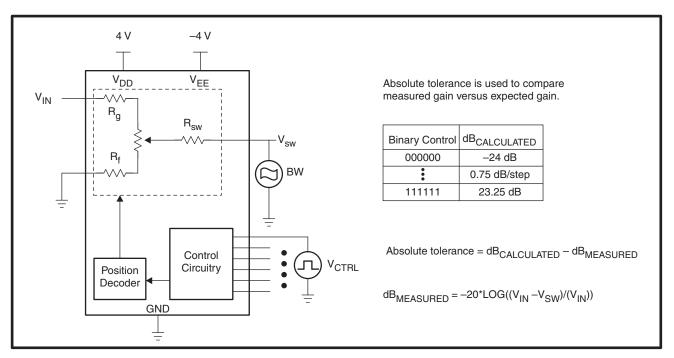
(1) Typical bandwidth shown in Figure 2 supports 6 MHz minimum.



TPL8002-25

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PARAMETER MEASUREMENT INFORMATION





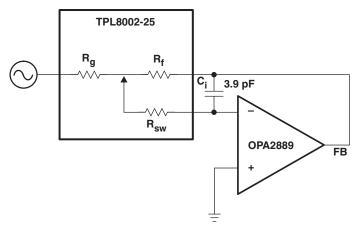


Figure 2. Bandwidth Setup

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | | ickage Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|---------------|----------------------------|------------------|------------------------------|
| TPL8002-25PWR | ACTIVE | TSSOP | PW | 16 2 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PACKAGE MATERIALS INFORMATION

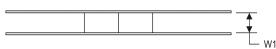
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TAPE AND REEL INFORMATION

REEL DIMENSIONS

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TAPE DIMENSIONS



| A0 | Dimension designed to accommodate the component width |
|----|---|
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

TAPE AND REEL INFORMATION

*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TPL8002-25PWR | TSSOP | PW | 16 | 2000 | 330.0 | 12.4 | 6.9 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |

TEXAS INSTRUMENTS

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PACKAGE MATERIALS INFORMATION

14-Jul-2012



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPL8002-25PWR | TSSOP | PW | 16 | 2000 | 367.0 | 367.0 | 35.0 |

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES:

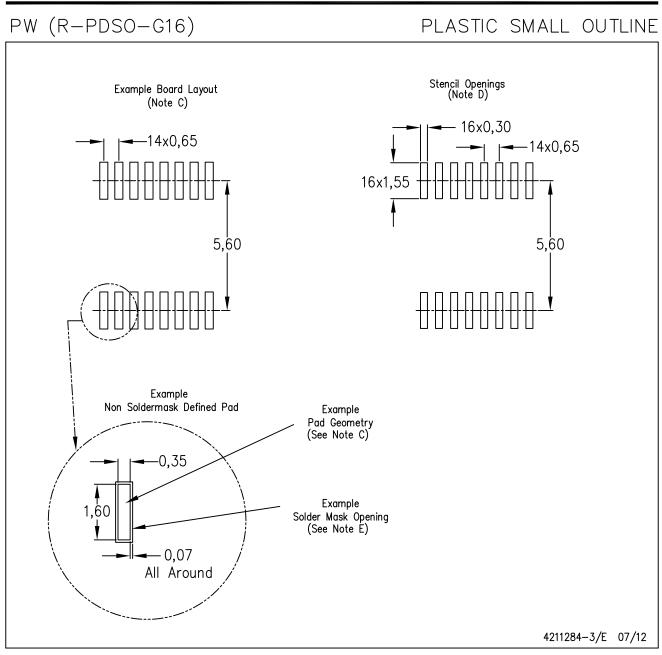
A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994. β . This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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